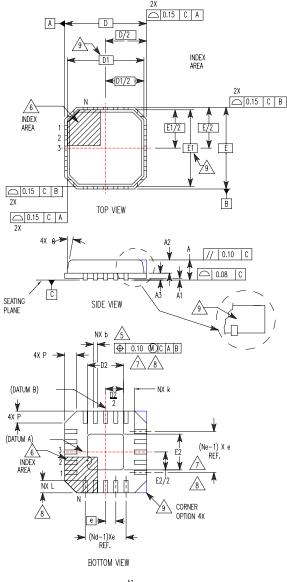
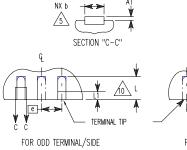
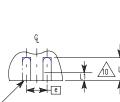
Quad Flat No-Lead Plastic Package (QFN) Micro Lead Frame Plastic Package (MLFP)







FOR EVEN TERMINAL/SIDE

L20.5x5

20 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE

	MILLIMETERS			
SYMBOL	MIN	NOMINAL	MAX	NOTES
А	0.80	0.90	1.00	-
A1	-	0.02	0.05	-
A2	-	0.65	1.00	9
A3	0.20 REF			9
b	0.23	0.30	0.38	5, 8
D	5.00 BSC			-
D1	4.75 BSC			9
D2	2.95	3.10	3.25	7, 8
E	5.00 BSC			-
E1	4.75 BSC			9
E2	2.95	3.10	3.25	7, 8
е	0.65 BSC			-
k	0.20	-	-	-
L	0.35	0.60	0.75	8
Ν	20			2
Nd	5			3
Ne	5			3
Р	-	-	0.60	9
θ	-	-	12	9
Rev. 4 11/0				

NOTES:

- 1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
- 2. N is the number of terminals.
- 3. Nd and Ne refer to the number of terminals on each D and E.
- 4. All dimensions are in millimeters. Angles are in degrees.
- 5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
- 8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
- 9. Features and dimensions A2, A3, D1, E1, P & 0 are present when Anvil singulation method is used and not present for saw singulation.
- 10. Compliant to JEDEC MO-220VHHC Issue I except for the "b" dimension.

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